- **Member of the Texas Instruments** Widebus™ Family
- Operates From 1.65 V to 3.6 V
- Max t_{pd} of 3 ns at 3.3 V
- ±24-mA Output Drive at 3.3 V
- Bus Hold on Data Inputs Eliminates the **Need for External Pullup/Pulldown** Resistors
- Latch-Up Performance Exceeds 250 mA Per **JESD 17**
- **ESD Protection Exceeds JESD 22**
 - 2000-V Human-Body Model (A114-A)
 - 200-V Machine Model (A115-A)

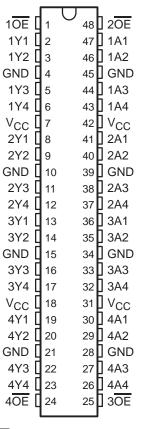
description/ordering information

This 16-bit buffer/driver is designed for 1.65-V to 3.6-V V_{CC} operation.

The SN74ALVCH16244 is designed specifically to improve the performance and density of 3-state memory address drivers, clock drivers, and bus-oriented receivers and transmitters.

The device can be used as four 4-bit buffers, two 8-bit buffers, or one 16-bit buffer. It provides true and symmetrical active-low output-enable (\overline{OE}) inputs.

DGG, DGV, OR DL PACKAGE (TOP VIEW)



To ensure the high-impedance state during power up or power down, $\overline{\sf OE}$ should be tied to ${\sf V_{CC}}$ through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

Active bus-hold circuitry holds unused or undriven inputs at a valid logic state. Use of pullup or pulldown resistors with the bus-hold circuitry is not recommended.

ORDERING INFORMATION

TA	PACKAGE [†]		ORDERABLE PART NUMBER	TOP-SIDE MARKING
	0000 0	Tube	SN74ALVCH16244DL	ALVOLI40044
	SSOP – DL	Tape and reel	SN74ALVCH16244DLR	ALVCH16244
-40°C to 85°C	TSSOP – DGG	Tape and reel	SN74ALVCH16244DGGR	ALVCH16244
-40 C to 65 C	TVSOP – DGV	Tape and reel	SN74ALVCH16244DGVR	VH244
	VFBGA – GQL	Tone and real	SN74ALVCH16244KR	VH244
	VFBGA – ZQL (Pb-free)	BGA – ZQL (Pb-free)		V П 244

[†] Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



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GQL OR ZQL PACKAGE (TOP VIEW)

	_	1	2	3	4	5	6
Α	$ \left(\right. $	\bigcirc	\bigcirc	\bigcirc	\bigcirc	\bigcirc	\bigcirc
В		\bigcirc	\bigcirc	\bigcirc	\bigcirc	\bigcirc	\bigcirc
С		\bigcirc	\bigcirc	\bigcirc	\bigcirc	\bigcirc	\bigcirc
D		\bigcirc	\bigcirc	\bigcirc	\bigcirc	\bigcirc	\bigcirc
Е		\bigcirc	\bigcirc			\bigcirc	\bigcirc
F		\bigcirc	\bigcirc			\bigcirc	\bigcirc
G		\bigcirc	\bigcirc	\bigcirc	\bigcirc	\bigcirc	\bigcirc
н		\bigcirc	\bigcirc	\bigcirc	\bigcirc	\bigcirc	\bigcirc
J		\bigcirc	\bigcirc	\bigcirc	\bigcirc	\bigcirc	\bigcirc
K		\bigcirc	\bigcirc	\bigcirc	\bigcirc	\bigcirc	\bigcirc

terminal assignments

	1	2	3	4	5	6
Α	1OE	NC	NC	NC	NC	2 <mark>OE</mark>
В	1Y2	1Y1	GND	GND	1A1	1A2
С	1Y4	1Y3	Vcc	Vcc	1A3	1A4
D	2Y2	2Y1	GND	GND	2A1	2A2
Е	2Y4	2Y3			2A3	2A4
F	3Y1	3Y2		_	3A2	3A1
G	3Y3	3Y4	GND	GND	3A4	3A3
Н	4Y1	4Y2	VCC	VCC	4A2	4A1
J	4Y3	4Y4	GND	GND	4A4	4A3
K	40E	NC	NC	NC	NC	3OE

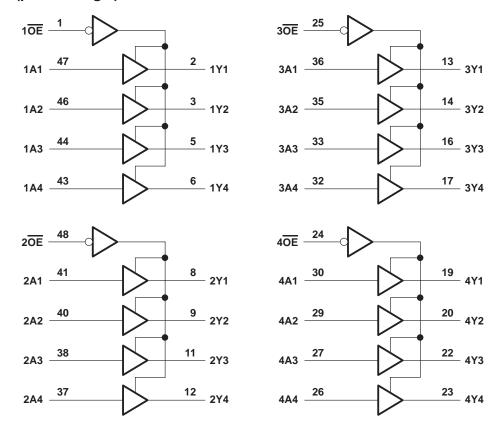
NC - No internal connection

FUNCTION TABLE (each 4-bit buffer)

INPU	JTS	OUTPUT
OE	Α	Υ
L	Н	Н
L	L	L
Н	X	Z



logic diagram (positive logic)



Pin numbers shown are for the DGG, DGV, and DL packages.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V _{CC}		
Output voltage range, V_0 (see Notes 1 and 2)		
Input clamp current, I_{IK} ($V_I < 0$)		
Output clamp current, I _{OK} (V _O < 0)		–50 mA
Continuous output current, IO		±50 mA
Continuous current through each V _{CC} or GND		±100 mA
Package thermal impedance, θ_{JA} (see Note 3):	DGG package	70°C/W
	DGV package	58°C/W
	DL package	63°C/W
	GQL/ZQL package	42°C/W
Storage temperature range, T _{Stg}		–65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input negative-voltage and output voltage ratings may be exceeded if the input and output current ratings are observed.
 - 2. This value is limited to 4.6 V maximum.
 - 3. The package thermal impedance is calculated in accordance with JESD 51-7.



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recommended operating conditions (see Note 4)

			MIN	MAX	UNIT
VCC	Supply voltage		1.65	3.6	V
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$	0.65 × V _{CC}		
V_{IH}	High-level input voltage	$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	1.7		V
		$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$	2		
		V _{CC} = 1.65 V to 1.95 V		0.35 × V _{CC}	
V_{IL}	L Low-level input voltage	$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		0.7	V
		$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$		0.8	
٧ _I	Input voltage		0	VCC	V
٧o	Output voltage		0	Vcc	V
		V _{CC} = 1.65 V		-4	
	I Park Javed and an extract	V _{CC} = 2.3 V	-12		4
ЮН	High-level output current	V _{CC} = 2.7 V		-12 m	
		V _{CC} = 3 V		-24	
		V _{CC} = 1.65 V		4	
	Law L	V _{CC} = 2.3 V		12	4
loL	Low-level output current	V _{CC} = 2.7 V	12		mA
		V _{CC} = 3 V		24	
Δt/Δν	Input transition rise or fall rate			10	ns/V
TA	Operating free-air temperature		-40	85	°C

NOTE 4: All unused control inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.



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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PA	RAMETER	TEST C	ONDITIONS	v _{cc}	MIN	TYP [†]	MAX	UNIT
		$I_{OH} = -100 \mu A$		1.65 V to 3.6 V	V _{CC} -0	.2		
		$I_{OH} = -4 \text{ mA}$	1.65 V	1.2				
		I _{OH} = -6 mA		2.3 V	2			
Vон				2.3 V	1.7			V
		I _{OH} = -12 mA		2.7 V	2.2			
				3 V	2.4			
		I _{OH} = -24 mA		3 V	2			
		I _{OL} = 100 μA		1.65 V to 3.6 V			0.2	
		I _{OL} = 4 mA		1.65 V			0.45	
l		I _{OL} = 6 mA		2.3 V			0.4	
VOL			2.3 V			0.7	V	
		I _{OL} = 12 mA	2.7 V			0.4		
		I _{OL} = 24 mA	3 V			0.55		
Ιį		V _I = V _{CC} or GND		3.6 V			±5	μΑ
		V _I = 0.58 V		1.65 V	25			
		V _I = 1.07 V	1.65 V	-25				
		V _I = 0.7 V	2.3 V	45				
I _I (hold)		V _I = 1.7 V		2.3 V	-45			μΑ
(/		V _I = 0.8 V		3 V	75			
		V _I = 2 V		3 V	-75			
		$V_{I} = 0 \text{ to } 3.6 \text{ V}^{\ddagger}$		3.6 V			±500	
loz		$V_O = V_{CC}$ or GND		3.6 V			±10	μΑ
lcc		$V_I = V_{CC}$ or GND,	IO = 0	3.6 V			40	μΑ
Δlcc		One input at V _{CC} – 0.6 V,	Other inputs at V _{CC} or GND	3 V to 3.6 V			750	μΑ
Ci	Control inputs Data inputs	V _I = V _{CC} or GND		3.3 V		3		pF
Со	Outputs	$V_O = V_{CC}$ or GND		3.3 V		7		pF

[†] All typical values are at $V_{CC} = 3.3 \text{ V}$, $T_A = 25^{\circ}\text{C}$.

switching characteristics over recommended operating free-air temperature range (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V _{CC} = 1.8 V	V _{CC} =	2.5 V 2 V	VCC =	2.7 V	V _{CC} = ± 0.3	3.3 V 3 V	UNIT
	(INPOT)	(001701)	TYP	MIN	MAX	MIN	MAX	MIN	MAX	
^t pd	А	Υ	§	1	3.7		3.6	1	3	ns
t _{en}	ŌĒ	Y	§	1	5.7		5.4	1	4.4	ns
^t dis	ŌĒ	Y	§	1	5.2		4.6	1	4.1	ns

[§] This information was not available at the time of publication.

[‡] This is the bus-hold maximum dynamic current. It is the minimum overdrive current required to switch the input from one state to another.

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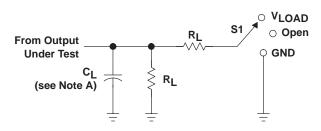
operating characteristics, $T_A = 25^{\circ}C$

	PARAMETER	TEST CONDITIONS	V _{CC} = 1.8 V	V _{CC} = 2.5 V	V _{CC} = 3.3 V	LINUT	
PARAMETER			TEST CONDITIONS	TYP	TYP	TYP	UNIT
<u> </u>	Power dissipation	Outputs enabled	C ₁ = 50 pF, f = 10 MHz	†	16	19	PΓ
Cpd	capacitance	Outputs disabled	CL = 50 pr, 1 = 10 MH2	†	4	5	ρг

[†] This information was not available at the time of publication.



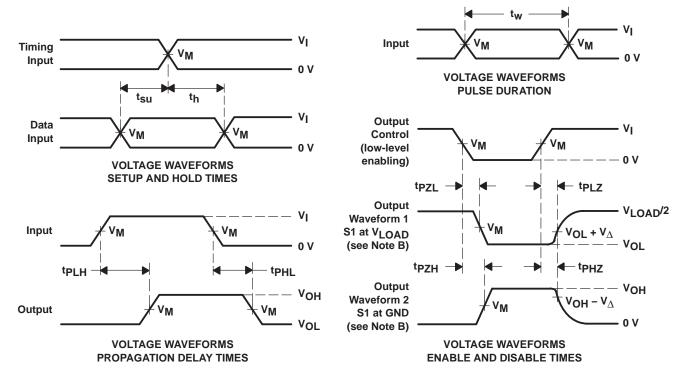
PARAMETER MEASUREMENT INFORMATION



TEST	S 1
^t pd	Open
t _{PLZ} /t _{PZL}	V _{LOAD}
t _{PHZ} /t _{PZH}	GND

LOAD CIRCUIT

V	IN	PUT	V	V	0.	D.	V
VCC	VI	t _r /t _f	VΜ	VLOAD	CL	RL	$v_{\scriptscriptstyle\Delta}$
1.8 V	VCC	≤ 2 ns	V _{CC} /2	2×V _{CC}	30 pF	1 k Ω	0.15 V
2.5 V \pm 0.2 V	VCC	≤2 ns	V _{CC} /2	2×V _{CC}	30 pF	500 Ω	0.15 V
2.7 V	2.7 V	≤2.5 ns	1.5 V	6 V	50 pF	500 Ω	0.3 V
3 V \pm 0.3 V	2.7 V	≤2.5 ns	1.5 V	6 V	50 pF	500 Ω	0.3 V



NOTES: A. C_L includes probe and jig capacitance.

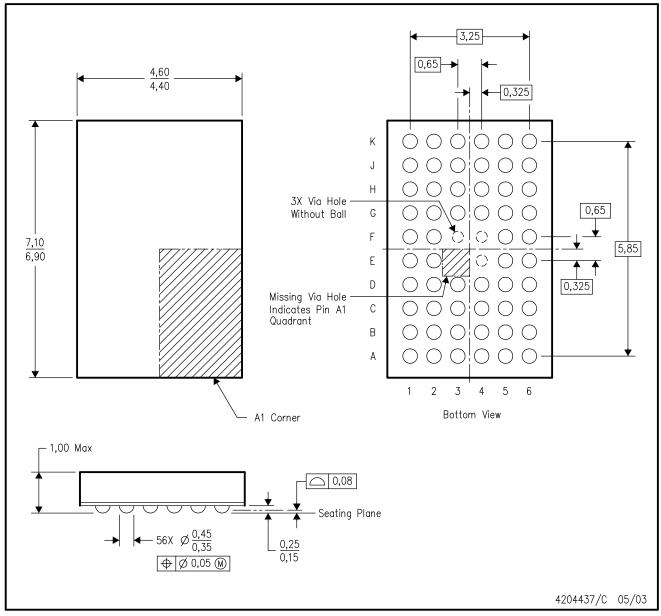
- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, $Z_O = 50~\Omega$.
- D. The outputs are measured one at a time with one transition per measurement.
- E. tpLZ and tpHZ are the same as tdis.
- F. tpzL and tpzH are the same as ten.
- G. tpLH and tpHL are the same as tpd.
- H. All parameters and waveforms are not applicable to all devices.

Figure 1. Load Circuit and Voltage Waveforms



ZQL (R-PBGA-N56)

PLASTIC BALL GRID ARRAY



NOTES:

- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. MicroStar Junior™ BGA configuration.
- D. Falls within JEDEC MO-225 variation BA.
- E. This package is lead-free. Refer to the 56 GQL package (drawing 4200583) for tin-lead (SnPb).

MicroStar Junior is a trademark of Texas Instruments.



DGV (R-PDSO-G**)

24 PINS SHOWN

PLASTIC SMALL-OUTLINE



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

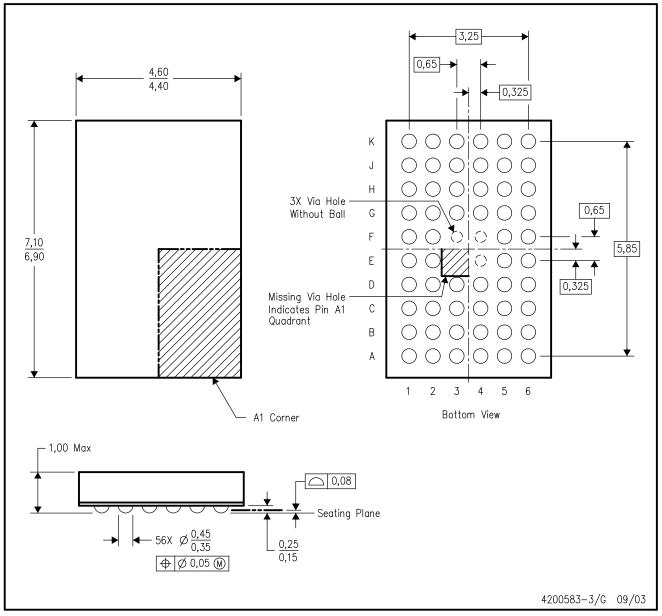
C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15 per side.

D. Falls within JEDEC: 24/48 Pins – MO-153 14/16/20/56 Pins – MO-194



GQL (R-PBGA-N56)

PLASTIC BALL GRID ARRAY



NOTES:

- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. MicroStar Junior™ BGA configuration.
- D. Falls within JEDEC MO-225 variation BA.
- E. This package is tin-lead (SnPb). Refer to the 56 ZQL package (drawing 4204437) for lead-free.

MicroStar Junior is a trademark of Texas Instruments.



DL (R-PDSO-G**)

48 PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).

D. Falls within JEDEC MO-118

DGG (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

48 PINS SHOWN



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold protrusion not to exceed 0,15.

D. Falls within JEDEC MO-153

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